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MOS FIELD EFFECT TRANSISTORS

2SK2367/2SK2368

SWITCHING
N-CHANNEL POWER MOS FET
INDUSTRIAL USE

DESCRIPTION

The 2SK2367/2SK2368 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-Resistance
  2SK2367: $R_{DS(on)}$ = 0.5 Ω (V_{GS} = 10 V, I_D = 8.0 A)
  2SK2368: $R_{DS(on)}$ = 0.6 Ω (V_{GS} = 10 V, I_D = 8.0 A)
- Low C_{iss} C_{iss} = 1 600 pF TYP.
- High Avalanche Capability Ratings

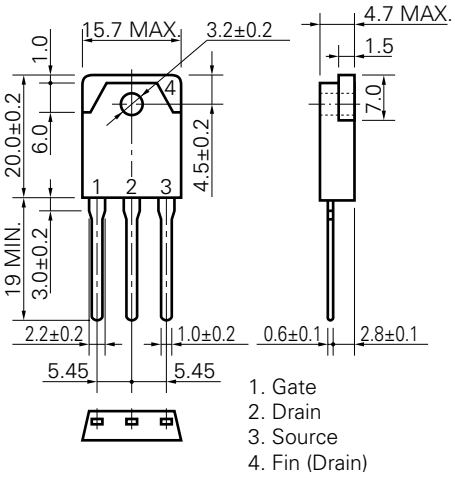
ABSOLUTE MAXIMUM RATINGS (T_A = 25 ˚C)

Drain to Source Voltage (2SK2367/2SK2368)	V_{DSS}	450/500	V
Gate to Source Voltage	V_{GSS}	±30	V
Drain Current (DC)	$I_{D(DC)}$	±15	A
Drain Current (pulse)*	$I_{D(pulse)}$	±60	A
Total Power Dissipation (T_c = 25 ˚C)	P_{T1}	120	W
Total Power Dissipation (T_A = 25 ˚C)	P_{T2}	3.0	W
Channel Temperature	T_{ch}	150	˚C
Storage Temperature	T_{stg}	–55 to +150	˚C
Single Avalanche Current**	I_{AS}	15	A
Single Avalanche Energy**	E_{AS}	161	mJ

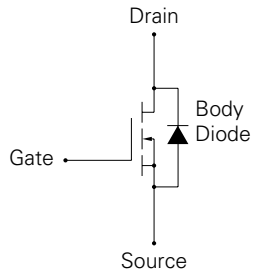
* PW ≤ 10 μs, Duty Cycle ≤ 1 %

** Starting T_{ch} = 25 ˚C, R_G = 25 Ω, V_{GS} = 20 V → 0

PACKAGE DIMENSIONS
(in millimeter)



MP-88



Document No. TC-2506
(O. D. No. TC-8065)
Date Published December 1994 P
Printed in Japan

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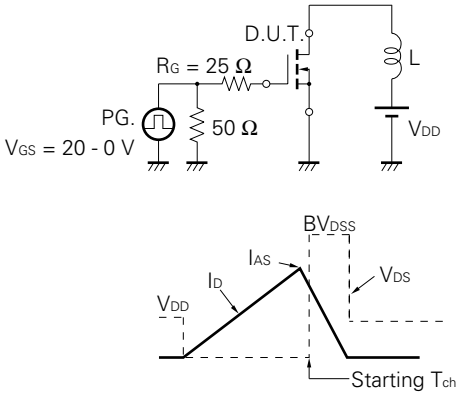
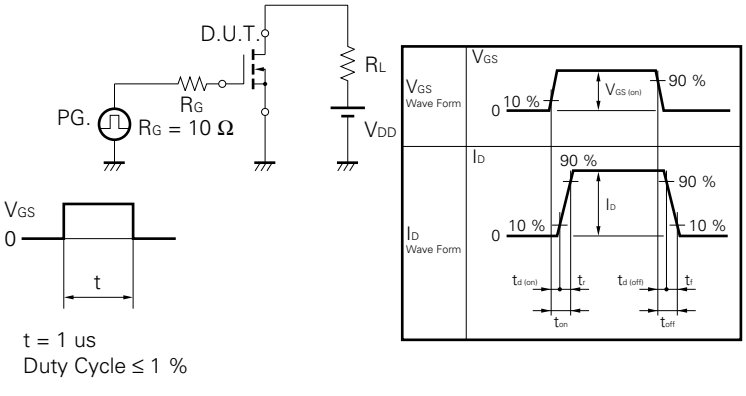
ELECTRICAL CHARACTERISTICS (T_A = 25 ˚C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	$R_{DS\ (on)}$		0.4	0.5	Ω	V_{GS} = 10 V	2SK2367
			0.5	0.6		I_D = 8.0 A	2SK2368
Gate to Source Cutoff Voltage	$V_{GS\ (off)}$	2.5		3.5	V	V_{DS} = 10 V, I_D = 1 mA	
Forward Transfer Admittance	$\lvert y_{fs} \rvert$	5.0			S	V_{DS} = 10 V, I_D = 8.0 A	
Drain Leakage Current	I_{DSS}			100	μA	V_{DS} = V_{DSS}, V_{GS} = 0	
Gate to Source Leakage Current	I_{GSS}			±100	nA	V_{GS} = ±30 V, V_{DS} = 0	
Input Capacitance	C_{iss}		1 600		pF	V_{DS} = 10 V	
Output Capacitance	C_{oss}		300		pF	V_{GS} = 0	
Reverse Transfer Capacitance	C_{rss}		30		pF	f = 1 MHz	
Turn-On Delay Time	$t_{d\ (on)}$		30		ns	I_D = 8.0 A	
Rise Time	t_r		40		ns	V_{GS} = 10 V	
Turn-Off Delay Time	$t_{d\ (off)}$		70		ns	V_{DD} = 150 V	
Fall Time	t_f		25		ns	R_G = 10 Ω R_L = 18.8 Ω	
Total Gate Charge	Q_G		43		nC	I_D = 15 A	
Gate to Source Charge	Q_{GS}		10		nC	V_{DD} = 400 V	
Gate to Drain Charge	Q_{GD}		20		nC	V_{GS} = 10 V	
Body Diode Forward Voltage	$V_{F\ (S-D)}$		1.0		V	I_F = 15 A, V_{GS} = 0	
Reverse Recovery Time	t_{rr}		400		ns	I_F = 15 A, V_{GS} = 0	
Reverse Recovery Charge	Q_{rr}		1.8		μC	di/dt = 50 A/μs	

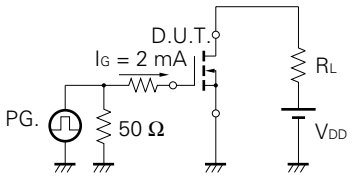
Test Circuit 1 Avalanche Capability



Test Circuit 2 Switching Time



Test Circuit 3 Gate Charge



The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

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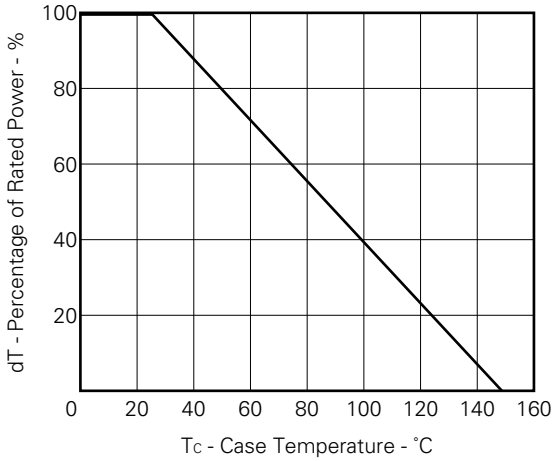
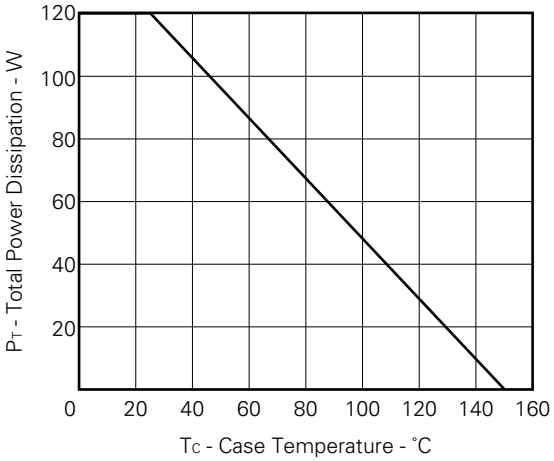
TYPICAL CHARACTERISTICS (T_A = 25 ˚C)

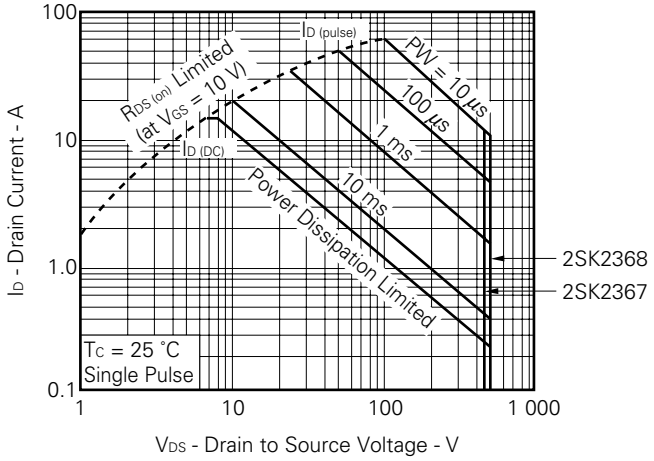
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



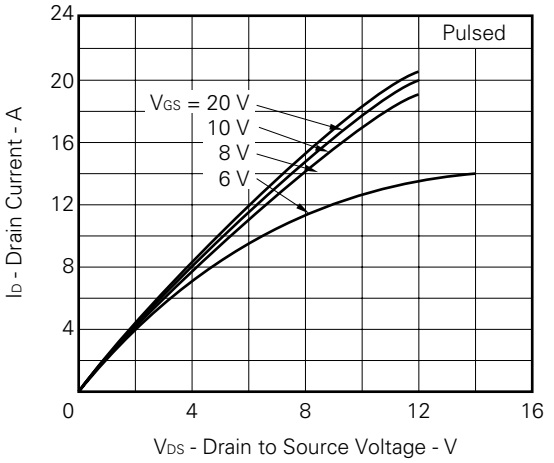
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



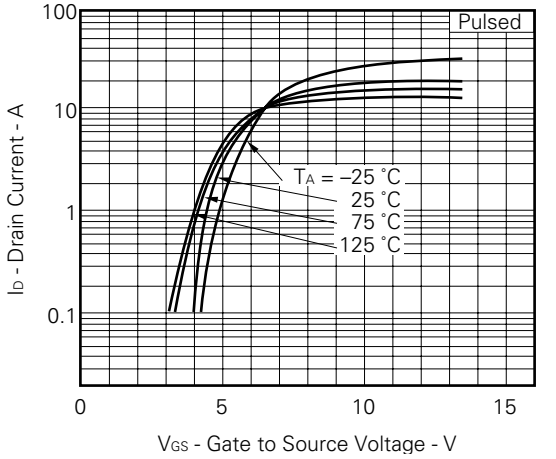
FORWARD BIAS SAFE OPERATING AREA



DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE



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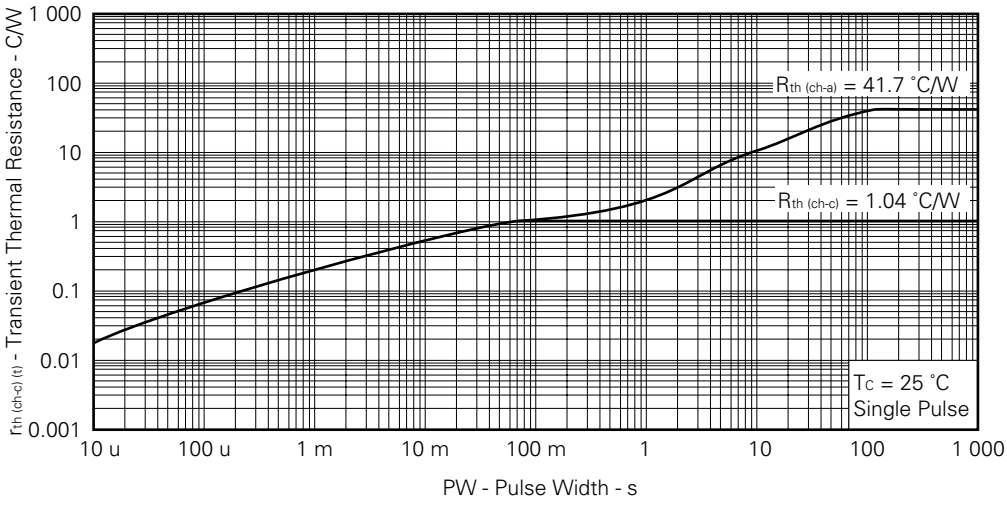
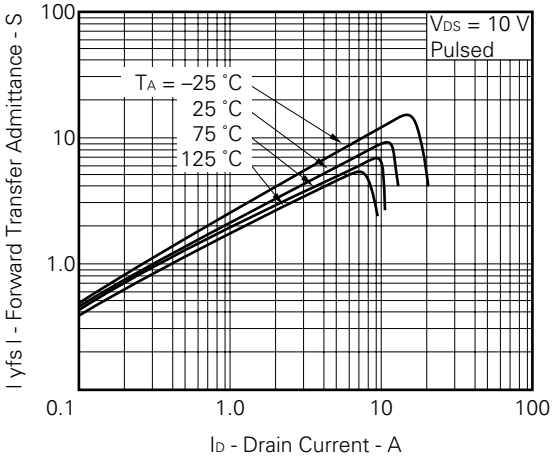
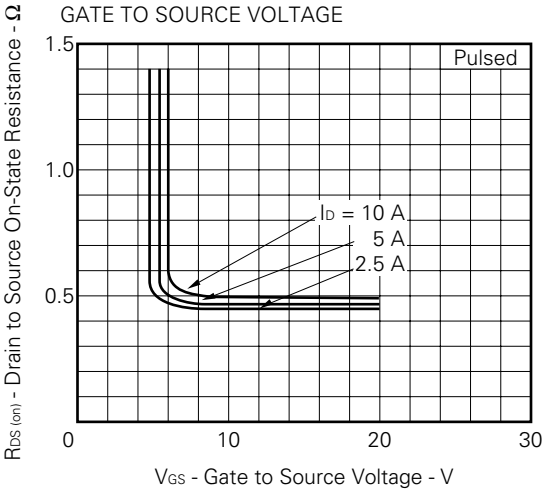
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



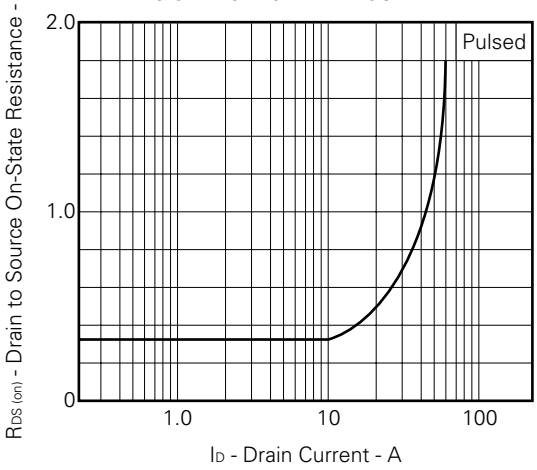
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



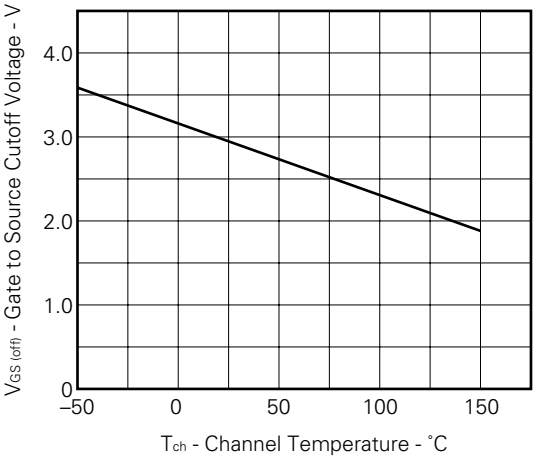
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



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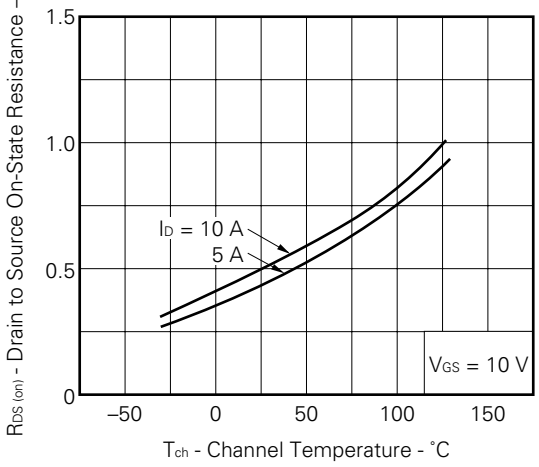
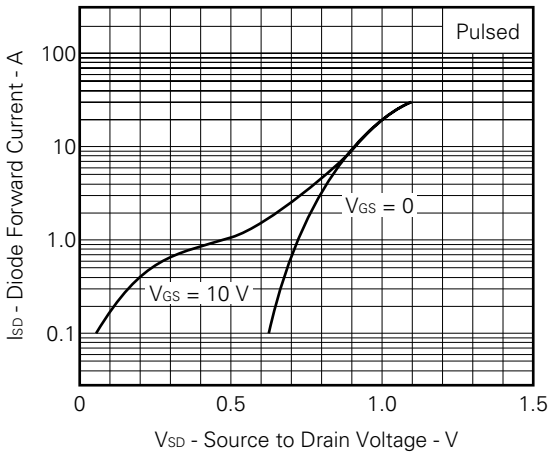
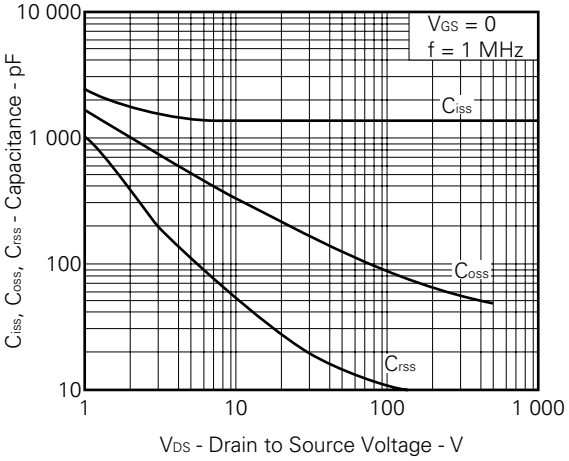
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



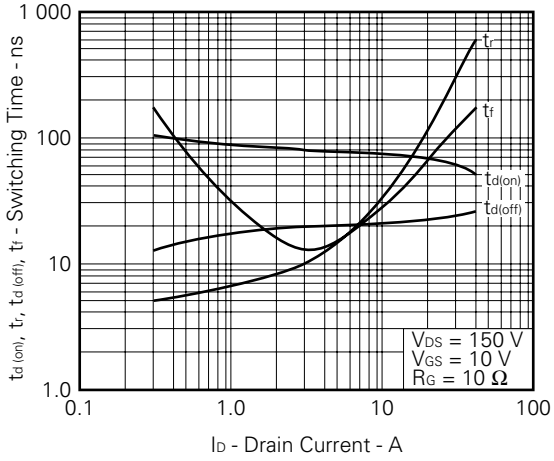
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



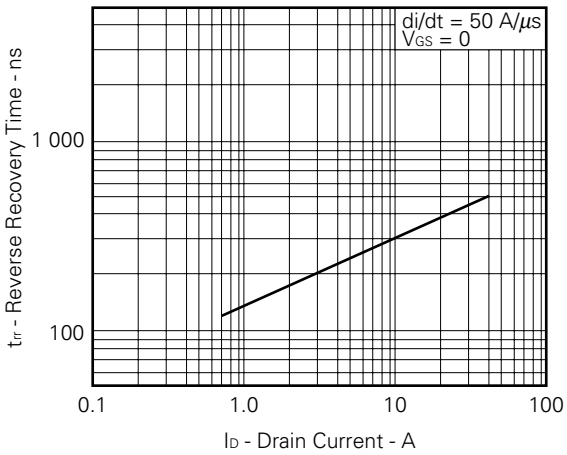
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



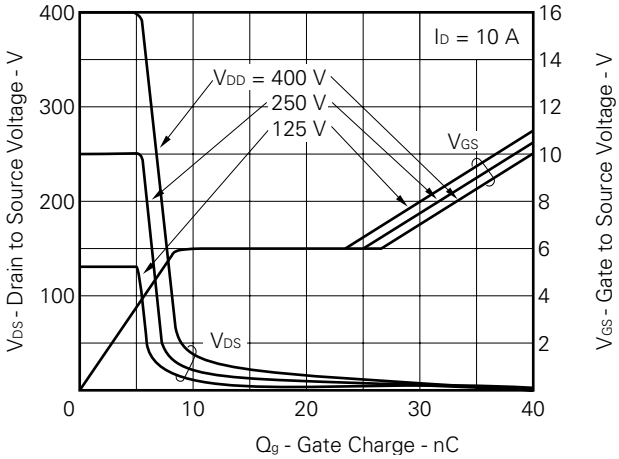
SWITCHING CHARACTERISTICS



REVERSE RECOVERY TIME vs. DRAIN CURRENT



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



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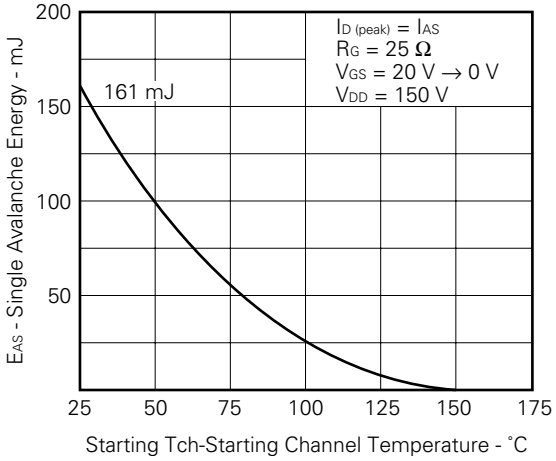
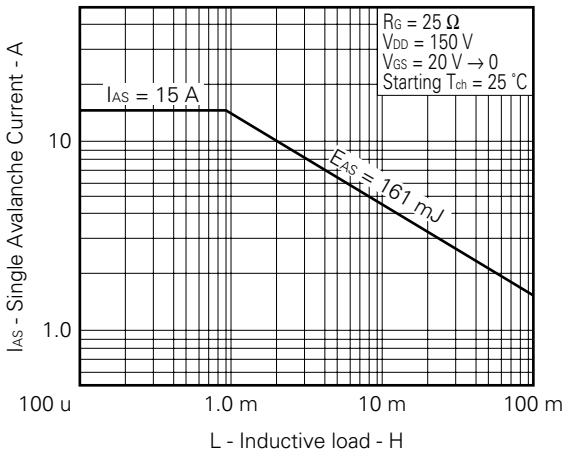
SINGLE AVALANCHE ENERGY vs.
STARTING CHANNEL TEMPERATURE



SINGLE AVALANCHE CURRENT vs.
INDUCTIVE LOAD



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Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

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